

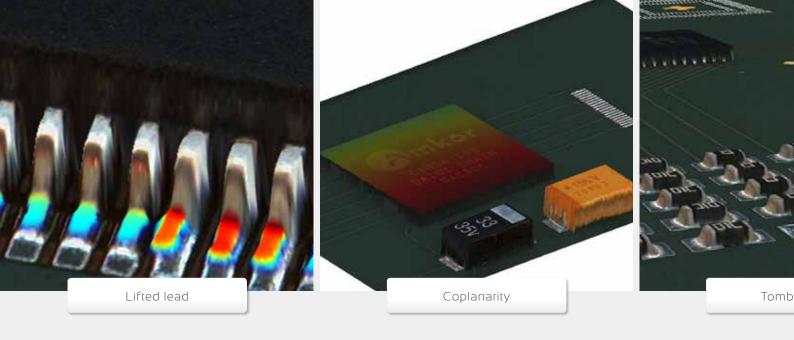


Shift defect coverage boundaries

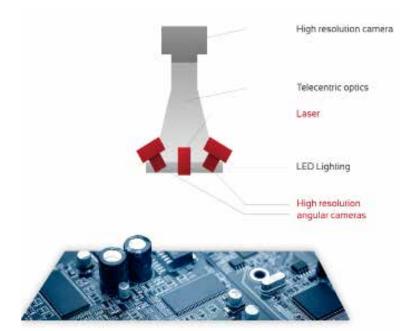
3D AOI



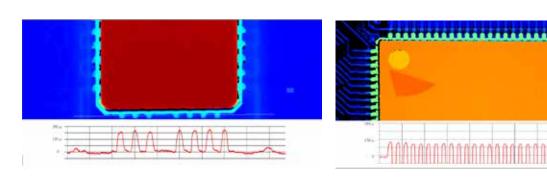




A powerful 3D to expand proven 2D technology

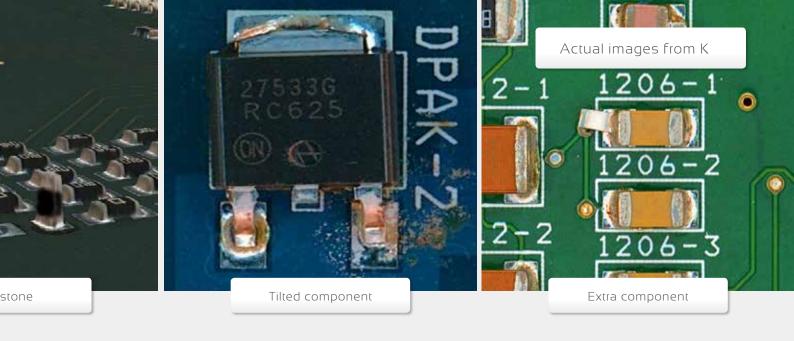


K Series^{3D} is the 3D successor of the production proven K Series with 3 500 systems sold in 40 countries. Using proprietary shadow-free 3D sensor developed and manufactured in Europe, K Series^{3D} shifts defect coverage boundaries. This new technology is compatible with existing K Series library and is available as an upgrade to existing K Series systems for 5K models or higher.



QFN Solder joint presence/absence

QFP Lifted leads



Complete defect coverage



Coverage

Comprehensive defect coverage

Component body

Missing component
Misplacement (X, Y, Z, θ)
Tombstone
Polarity
Coplanarity
Upside-down component

OCR, OCV

Solder joint

Missing joint, solder excess Bridging Lifted lead Head-in-pillow



Performance

The choice of Industry leaders

Up time superior to 99.5%

Very low false calls and escapes rate down to 50 ppm in production

X, Y GRR << 4% on 01005

Inspection time up to 100 cm/s

Fast programming time

Compatibility with existing K Series libraries

LibraryPro to guarantee performance over time

Full program portability

GPU based processing



Accuracy

High precision optical metrology system

Shadow-free 3D Sensor

12-bit 8 M Pixel CCD Camera

Telecentric Lens

LED lighting with holographic diffuser

High precision linear motors, 1 µm repeatability, with linear optical encoders

X,Y resolution 20 μm

Z resolution 1 μm

25 mm range reconstruction

Geometric pattern matching



Specifications

Field of view dimensions

Components inspected per hour







Blue laser (*) with 2 angular cameras 8 M Pixel, 12-bit CCD Telecentric lens 61.1 x 44.9 mm² (2.40" x 1.76") White, Red, Blue Axial and peripheral LED with holographic diffuser 480 000

System

Lighting colors

Lighting types

Camera

Optics

Operating System Processor Storage capacity PCB positioning Motion & control

WINDOWS 7, 64-bit Intel Core i7 8-Core, 32 GB memory 500 GB SATA3 Board and panel fiducials Linear motors with optical encoders

Software Suite

Vision integrated software suite Vision Offline repair software Vision Offline programming software Offline programming software Offline SPC

Vision3D Standard based on JEDEC packages Standard Optional SIGMA Import (CAD Data) SIGMA Analysis

Options

External barcode reader (ID/2D) Internal barcode reader (ID/2D) Others

Cognex DM100, compatible with major barcode readers Yes Consult us

860 - 960 mm

PCB handling

PCB thickness

Top clearance

Bottom clearance

Maximum PCB weight

Minimum edge clearance

Conveying height Minimum PCB dimensions (L x W) Maximum PCB dimensions (L x W)

2" x 2" (51x51 mm) 21" x 24" (533 x 609 mm)

2" x 2" (51x51 mm) 2" x 2" (51x51 mm) Dual lane mode 21" x 24" (533,4 x 609,6 mm 2 x (17" x 12,8") (2 x (432 x325) mm) 37" x 24" (option) (939 x 609 mm)

Single lane mode 17" x 23,6" (432 x 600 mm)

60 mm

0.5 - 4 mm 3 ka 3 mm

0.5 - 4 mm 3 ka 3 mm 34mm

0.5 - 15 mm 15 kg 5 mm

Facilities

Interface Power requirements Dimensions (W \times D \times H) Weight Operation temperature Relative humidity Network

IPC-SMEMA-9851 115 V / 60 Hz / 16 A, 230 V / 50 Hz / 10 A 1 110 mm x 1 351 mm x 1 892 mm 900 kg 15°C to 30°C 20-75% (without condensing) TCP/IP, RJ45 plug

Field upgradeability K Series → K Series3D

(*) K3D equipments are class I laser products, according to IEC60825-I:2014-I standard Please refer to specific Vi TECHNOLOGY instructions regarding operation 6 maintenan



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